

/ Descriptions

WR0<5    M M E SQS æ M ç s ll 1    Silicon PNP transistor in a TO-92 Plastic Package.

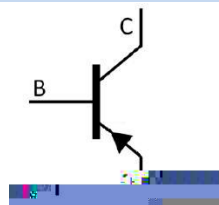
/ Features

лЪ NVF<78 Ы ´  
Complementary pair with KSC945.

/ Applications

æ æ H l ð z  
Low frequency amplifier applications.

/ Equivalent Circuit



/ Pinning



PIN1 χ Collector      PIN 2 χ Base      PIN 3 χ Emitter

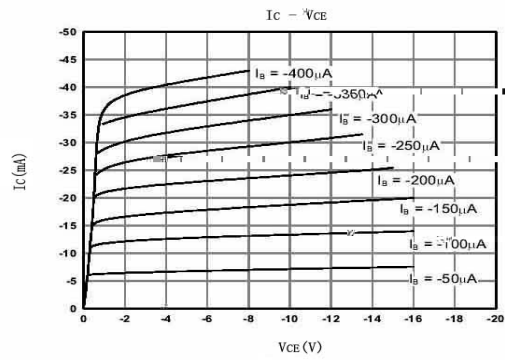
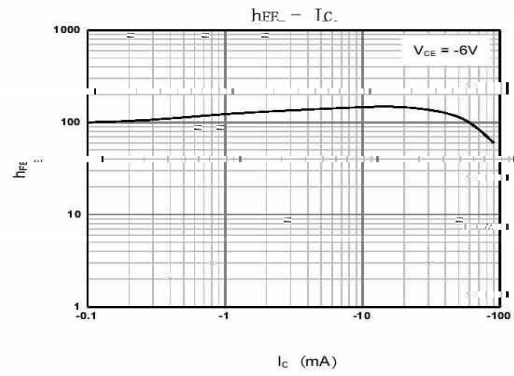
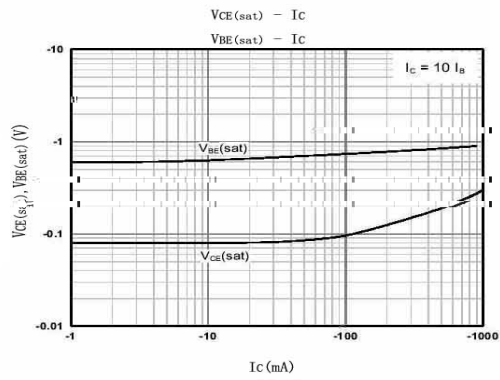
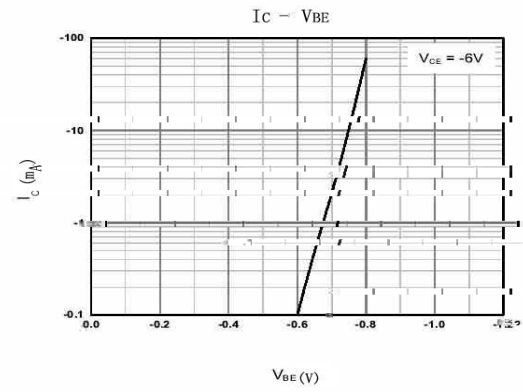
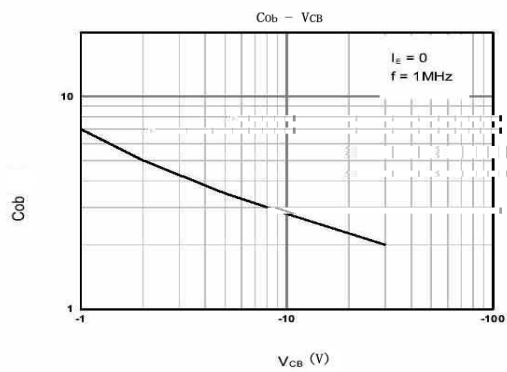
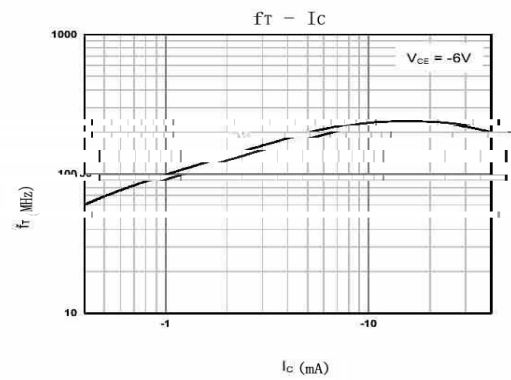
/ hFE Classifications & Marking

| h <sub>FE</sub> Classifications<br>Symbol | R     | O      | Y       | G       | L       |
|-------------------------------------------|-------|--------|---------|---------|---------|
| h <sub>FE</sub> Range                     | 40~80 | 70~140 | 120~140 | 200~400 | 350~700 |

| Parameter                      | Symbol    | Rating  | Unit |
|--------------------------------|-----------|---------|------|
| Collector to Base Voltage      | $V_{CBO}$ | -60     | V    |
| Collector to Emitter Voltage   | $V_{CEO}$ | -50     | V    |
| Emitter to Base Voltage        | $V_{EBO}$ | -5.0    | V    |
| Collector Current - Continuous | $I_C$     | -150    | mA   |
| Collector Power Dissipation    | $P_C$     | 250     | mW   |
| Junction Temperature           | $T_J$     | 150     |      |
| Storage Temperature Range      | $T_{stg}$ | -55 150 |      |

|           |        |      |
|-----------|--------|------|
| Parameter | Symbol | Unit |
|-----------|--------|------|

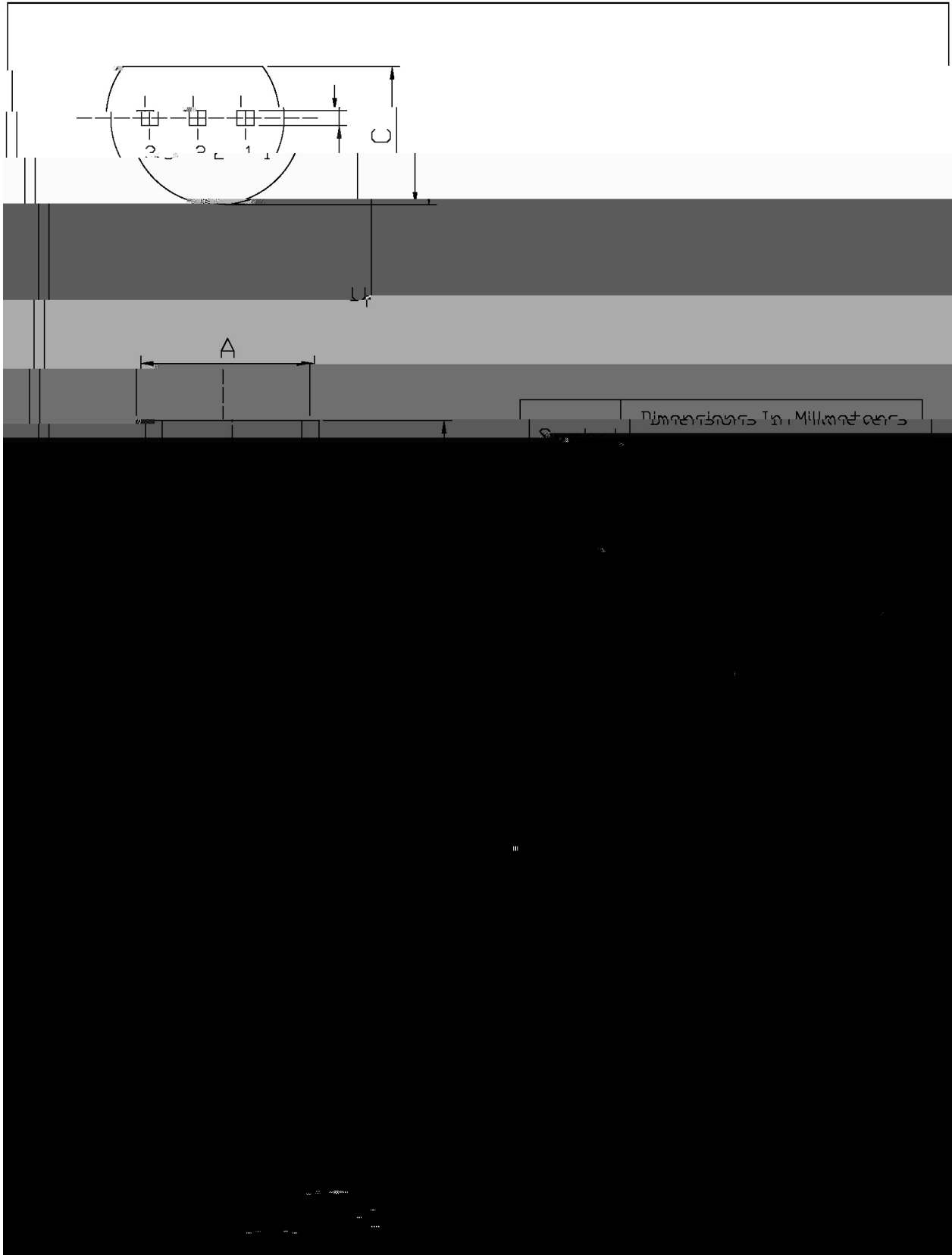
**/ Electrical Characteristic Curve**



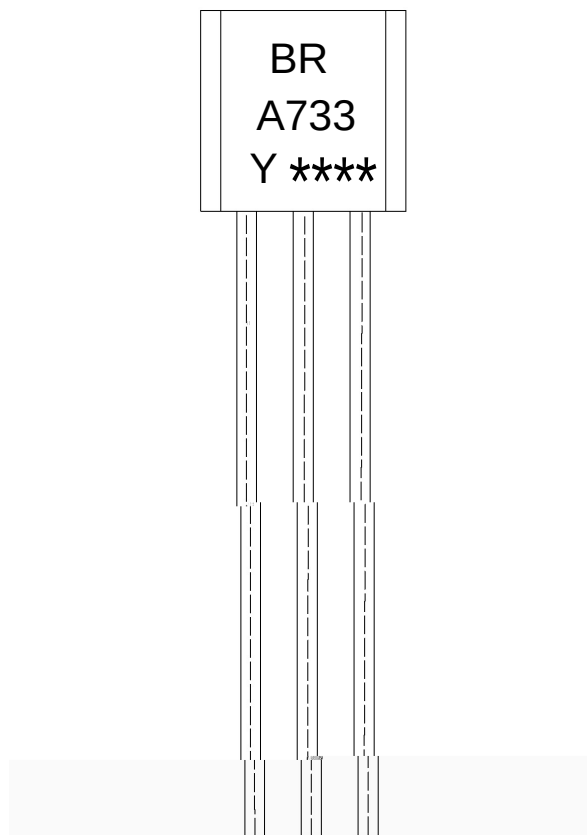
/ Package Dimensions

T0-92

Unit: mm



## / Marking Instructions



б " X

EU:

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D: 66 X

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---- X

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Note:

BR:

Company Code.

A733:

Product Type.

Y:

$h_{FE}$  Classifications Symbol

\*\*\*\*:

Lot No. Code, code change with Lot No.

### ( ) / Temperature Profile for Dip Soldering(Pb-Free)



б " X

1. 1. Preheating: 25~150 °C, Time: 60~90sec;
2. 2. Peak Temp.: 255 °C, Duration: 5 ° 0.5sec;
3. 3. Cooling Speed: 2~10 ° /sec.

Note:

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2. Peak Temp.: 255 °C, Duration: 5 ° 0.5sec.
3. Cooling Speed: 2~10 ° /sec.

### / Resistance to Soldering Heat Test Conditions

□ °C 270 ± 5 °C, Time: 10 ± 1 sec. Temp: 270 ± 5 °C Time: 10 ± 1 sec

### / Packaging SPEC.

“Q” T Y E / BULK

| Package Type | Units       |                  |                   |                         |                   | Dimension (unit mm3) |             |             |
|--------------|-------------|------------------|-------------------|-------------------------|-------------------|----------------------|-------------|-------------|
|              | Units/Bag / | Bags/Inner Box / | Units/Inner Box / | Inner Boxes/Outer Box / | Units/Outer Box / | Bag                  | Inner Box   | Outer Box   |
| TO-92        | 1,000       | 10               | 10,000            | 5                       | 50,000            | 135×190              | 237×172×102 | 560×245×195 |
|              | 1,000       | 10               | 10,000            | 10                      | 100,000           | 135×190              | 237×172×102 | 560×245×375 |

“V” Y E / AMMO

| Package Type | Units        |                  |                  |                         |                   | Dimension (unit mm3) |                            |
|--------------|--------------|------------------|------------------|-------------------------|-------------------|----------------------|----------------------------|
|              | Units/tape / | Tape/Inner Box / | Rows/Inner Box / | Inner Boxes/Outer Box / | Units/Outer Box / | Inner Box            | Outer Box                  |
| TO-92        | 3,000        | 1                | 120              | 10                      | 30,000            | 328×230×42           | 480×346×235<br>547×407×268 |

### / Notices